

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	3464	spiral SAME embedd\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/22 11:46
L3	1051	2 and insulat\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/22 11:47
L4	8543	u WITH conductor	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/22 11:47
L5	10	3 and 4	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/22 14:59
L6	2734	(336/200,223,232).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/09/22 12:30
L8	49	2 and 6	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/22 12:17
L10	175	6 and (helix\$3 helical)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/22 12:51
L12	2656	chip NEAR1 inductor	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/22 12:52
L13	300641	(stack\$3 ADJ1 layer)(laminat\$3 ADJ1 layer)(multi\$1layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/22 12:53
L14	565	12 and 13	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/22 13:04
L15	487	14 and conduct\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/22 13:20

L16	130	14 and embedd\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/22 12:54
L19	3	14 and (U NEAR1 conductor)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/22 13:05
L26	369	15 and (insulat\$3 dielectric)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/22 15:00
L28	2	("4729510").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/09/22 15:37
L29	133	26 and resin and metal	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/22 15:06
L30	127	26 and resin and copper	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/22 15:06